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DPDT Non-Latching Electromechanical Relay Signal Integrity up to 20Gbps



# HIGH REPEATABILITY, DC-8 GHz/20Gbps TO-5 RELAYS, DPDT



SERIES	RELAY TYPE		
RF312	DPDT Non-latching, Repeatable, RF relay		
RF332	DPDT Non-latching, Low Power Operating Coil, RF relay		

#### DESCRIPTION

The ultra miniature RF312 is designed to improve upon the RF300/RF303 relay's high frequency performance. The RF312/RF332 offers monotonic insertion loss to 8 GHz. This improvement in RF insertion loss over the frequency range, makes these relays highly suitable for use in attenuator and other RF circuits. The sensitive RF332 relay has a high resistance coil, thus requiring extremely low operating power (200 mW typical).

## The RF312/RF332 features:

- · High repeatability.
- · Broader bandwidth.
- · Metal enclosure for EMI shielding.
- · Ground pin option to improve case grounding.
- High isolation between control and signal paths.
- · Highly resistant to ESD.

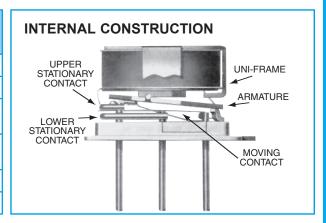
#### **CONSTRUCTION FEATURES**

The following unique construction features and manufacturing techniques provide excellent resistance to environmental extremes and overall reliability.

- Uni-frame motor design provides high magnetic efficiency and mechanical rigidity.
- Minimum mass components and welded construction provide maximum resistance to shock and vibration.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- Gold-plated precious metal alloy contacts ensure reliable switching and signal fidelity.
- · Hermetically sealed.
- Solder-Dipped Leads, (RoHS compliant solder option available)

	PHYSICAL SPECIFICATIONS			
	Temperature (Ambient)	Storage	–65°C to +125°C	
		Operating	–55°C to +85°C	
	Vibration (Note 1)		10 g's to 500 Hz	
	Shock (Note 1)		30 g's, 6ms half sine	
	Enclosure		Hermetically sealed	
	Weight		0.09 oz. (2.55g) max.	

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## GENERAL ELECTRICAL SPECIFICATIONS (-65°C to +125°C unless otherwise noted)(Notes 2 & 3)

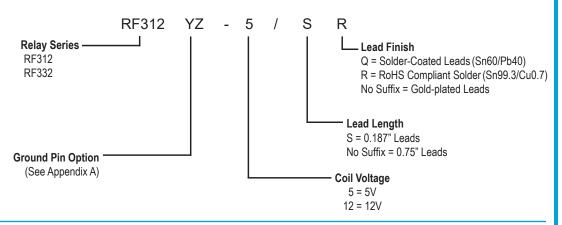
Contact Arrangement	2 Form C (DPDT)	
Rated Duty	Continuous	
Contact Resistance	$0.15~\Omega$ max.	
Contact Load Rating	Resistive: 1Amp/28Vdc Low level: 10 to 50 μA @ 10 to 50 mV	
Contact Life Ratings	1,000,000 cycles (typical) at low level contact load	
Coil Operating Power	RF312: 450 mW typical at nominal rated voltage RF332: 200 mW typical at nominal rated voltage	
Operate Time	RF312: 4.0 ms max. RF332: 6.0 ms max.	
Release Time	3.0 ms max.	
Intercontact Capacitance	0.4 pf typical	
Insulation Resistance	1,000 MΩ min. between mutually isolated terminals	
Dielectric Strength	350 Vrms (60 Hz) @ atmospheric pressure	

# DETAILED ELECTRICAL SPECIFICATIONS (-65°C to +125°C unless otherwise noted)(Note 3)

BASE PART NUMBERS (RF312)	RF312-5	RF312-12
Coil Voltage, Nominal (Vdc)	5.0	12.0
Coil Resistance (Ohms ±20%)	50	390
Pick-up Voltage (Vdc max.)	3.6	9.0

BASE PART NUMBERS (RF332)	RF332-5	RF332-12
Coil Voltage, Nominal (Vdc)	5.0	12.0
Coil Resistance (Ohms ±20%)	100	850
Pick-up Voltage (Vdc max.)	3.6	9.0

# Part Numbering System (Notes 4 & 5)

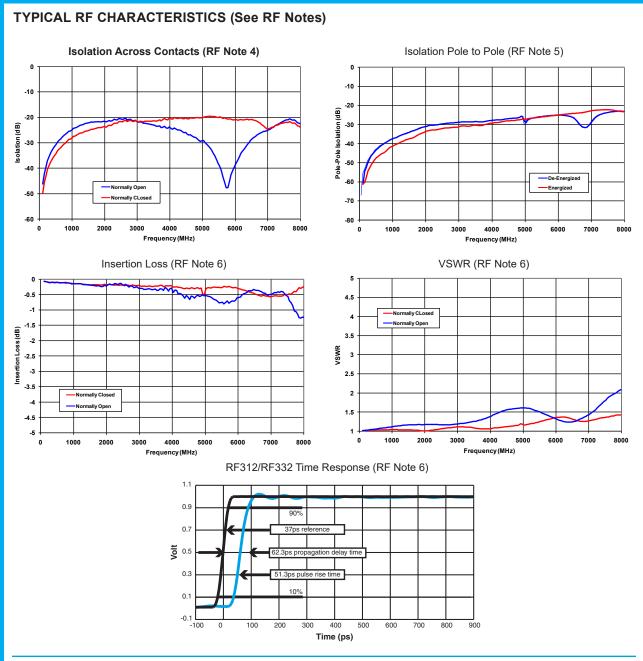


# **NOTES**

- 1. Relays will exhibit no contact chatter in excess of 10 µs or transfer in excess of 1 µs.
- 2. "Typical" characteristics are based on available data and are best estimates. No on-going verification tests are performed.
- 3. Unless otherwise specified, parameters are initial values.
- 4. The slash and characters appearing after the slash are not marked on the relay.
- 5. Unless otherwise specified, relays will be supplied with gold-plated leads.

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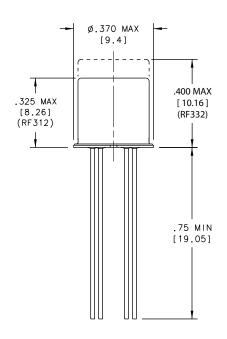
#### **RF NOTES**

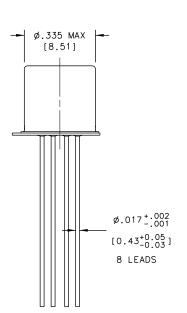
- 1. Test conditions: a. Fixture: .031" copper clad, reinforced PTFE, RT/duroid® 6002 with SMA connectors. (RT/duroid® is a registered trademark of Rogers Corporation.)
  - b. Room ambient temperature.
  - c. Terminals not tested were terminated with 50-ohm load.
  - d. Contact signal level: -10 dBm.
  - e. No. of test samples: 4.
- 2. Data presented herein represents typical characteristics and is not intended for use as specification limits.
- 3. Data is per pole, except for pole-to-pole data.
- 4. Data is the average from readings taken on all open contacts.
- 5. Data is the average from readings taken on poles with coil energized and de-energized.
- 6. Data is the average from readings taken on all closed contacts.
- 7. Test fixture effect de-embedded from frequency and time response data.

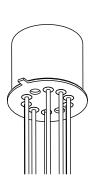
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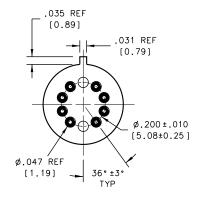
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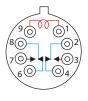
## **OUTLINE DIMENSIONS**











**SCHEMATIC DIAGRAM** 

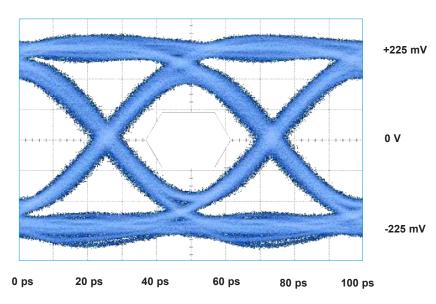
#### NOTES

- 1. DIMENSIONS ARE IN INCHES, METRIC EQUIVALENTS SHOWN IN [].
- 2. POSTITIONS 5 AND 10 ARE FOR UNINSULATED CASE GROUND OPTIONS.
- 3. NO PROTRUSION BELOW BOTTOM OF HEADER WHEN GROUND PINS ARE INSTALLED
- 4. TO ORDER THE CASE GROUND OPTION, AFTER THE SERIES DESIGNATOR, ADD "Y" TO THE PART NUMBER FOR POSITION 5 OR "Z" TO THE PART NUMBER FOR POSITION 10.

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# TYPICAL Single-Ended Signal Integrity Characteristics @ 20 Gbps



Bit Rate	Eye Height	Eye Width	Jitter <sub><sub>P-P</sub></sub>
20 Gbps	191 mV	37 ps	10.22 ps

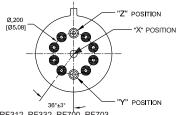
# **APPENDIX A: Spacer Pads**

Pad designation and bottom view dimensions	Height	For use with the following:	Dim. H Max.
Ø.150 [3.81] (REF)	Dim H MAX	RF312	.350 (8.89)

#### Notes:

- 1. Spacer pad material: Polyester film.
- 2. To specify an "M4" spacer pad, refer to the mounting variants portion of the part numbering example in the applicable datasheet.
- 3. Dimensions are in inches (mm).
- 4. Unless otherwise specified, tolerance is ± .010" (.25 mm).
- 5. Add 10  $\mbox{m}\Omega$  to the contact resistance shown in the datasheet.
- 6. Add 0.01 oz. (0.25 g) to the weight of the relay assembly shown in the datasheet.

# **APPENDIX A: Ground Pin Positions**



RF312, RF332, RF700, RF703

LINTIZ, LINTIZI, LINTZZ, LINTZZ, LINTZZI, 712, 712TN, 400H, 400K, 400V, RF300, RF303, RF312, RF332, RF310, RF313, RF320, RF323, SI800, SI803, RF700, RF703

- Indicates ground pin position
- Indicates glass insulated lead position
- Indicates ground pin or lead position depending on relay type

### **NOTES**

- 1. Terminal views shown
- 2. Dimensions are in inches (mm)
- 3. Tolerances: ± .010 (±.25) unless otherwise specified
- 4. Ground pin positions are within .015 (0.38) dia. of true position
- 5. Ground pin head dia., 0.035 (0.89) ref: height 0.010 (0.25) ref.
- 6. Lead dia. 0.017 (0.43) nom.
- 7. "X" and "Z" Positions are not applicable for JAN Relays